

1N4148WS-BL-CH

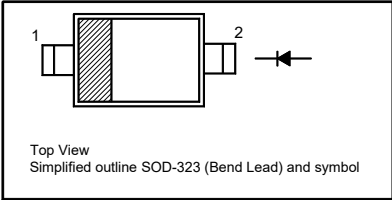
Silicon Epitaxial Planar Switching Diode

Features

- AEC-Q101 Qualified
- Fast switching
- Halogen and Antimony Free(HAF), RoHS compliant

PINNING

PIN	DESCRIPTION
1	Cathode
2	Anode



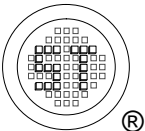
Absolute Maximum Ratings ($T_a = 25^{\circ}\text{C}$)

Parameter	Symbol	Value	Unit
Peak Reverse Voltage	V_{RM}	100	V
Reverse Voltage	V_R	75	V
Average Rectified Forward Current	$I_{F(AV)}$	150	mA
Forward Continuous Current	I_{FM}	300	mA
Surge Forward Current	I_{FSM}	2 1	A
Power Dissipation ¹⁾	P_D	200	mW
Operating Junction Temperature Range	T_j	- 55 to + 150	$^{\circ}\text{C}$
Storage Temperature Range	T_{stg}	- 65 to + 150	$^{\circ}\text{C}$

Thermal Characteristics

Parameter	Symbol	Value	Unit
Thermal Resistance from Junction to Ambient ¹⁾	$R_{\theta JA}$	625	$^{\circ}\text{C/W}$

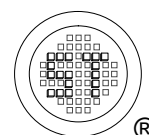
¹⁾ Device mounted on FR-4 substrate PC board, with minimum recommended pad layout.



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Characteristics at $T_a = 25^\circ\text{C}$

Parameter	Symbol	Min.	Max.	Unit
Reverse Breakdown Voltage at $I_R = 1\ \mu\text{A}$	$V_{(BR)R}$	75	-	V
Forward Voltage at $I_F = 1\ \text{mA}$ at $I_F = 10\ \text{mA}$ at $I_F = 50\ \text{mA}$ at $I_F = 150\ \text{mA}$	V_F	- - - -	0.715 0.855 1 1.25	V
Peak Reverse Current at $V_R = 75\ \text{V}$ at $V_R = 20\ \text{V}$ at $V_R = 75\ \text{V}$, $T_J = 150\ ^\circ\text{C}$ at $V_R = 25\ \text{V}$, $T_J = 150\ ^\circ\text{C}$	I_R	- - - -	1 25 50 30	μA nA μA μA
Total Capacitance at $V_R = 0\ \text{V}$, $f = 1\ \text{MHz}$	C_T	-	2	pF
Reverse Recovery Time at $I_R = 0.1 \times I_R$, $I_F = 10\ \text{mA}$, $V_R = 6\ \text{V}$, $R_L = 100\ \Omega$	t_{rr}	-	4	ns



Electrical Characteristics Curves

Fig. 1 Power Derating Curve

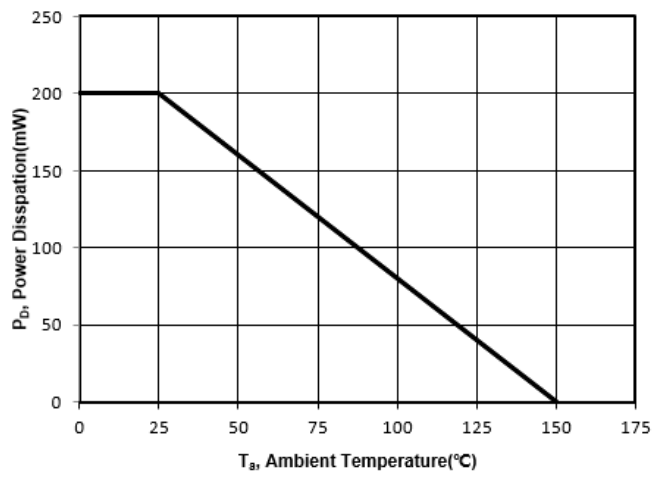


Fig. 2 Capacitance Characteristics

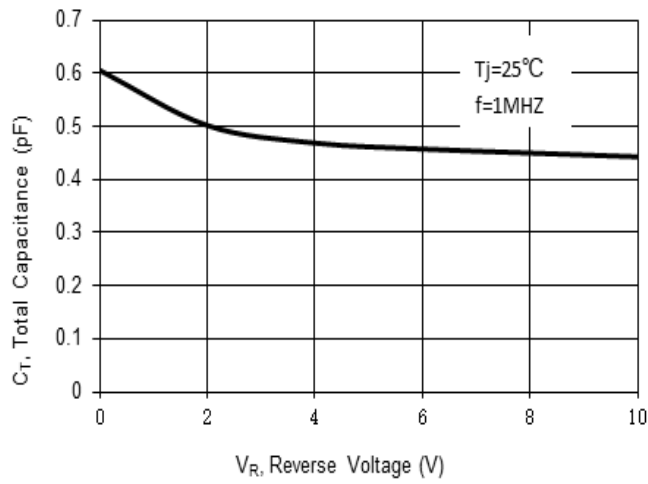


Fig. 3 Reverse Characteristics

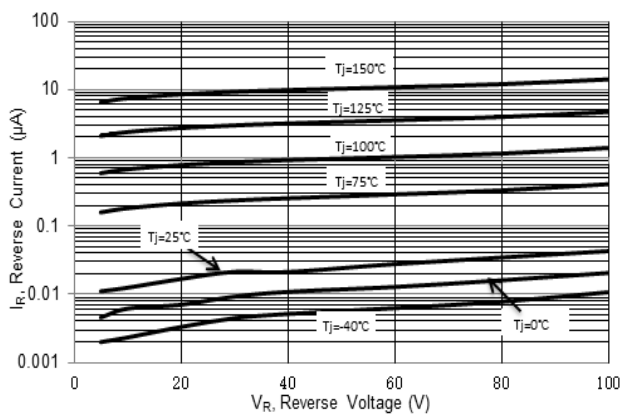
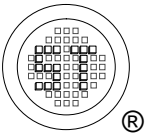
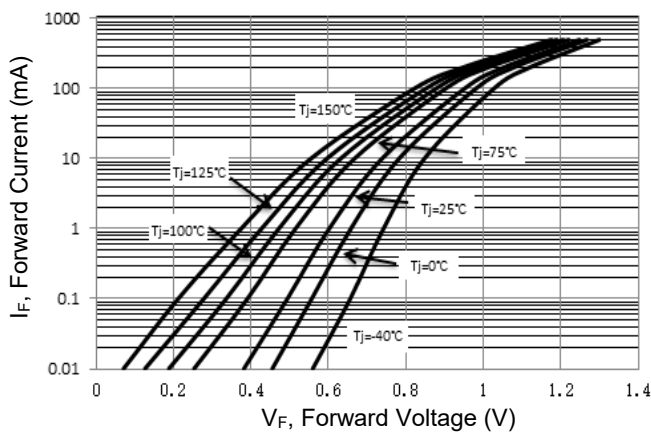


Fig. 4 Forward Characteristics

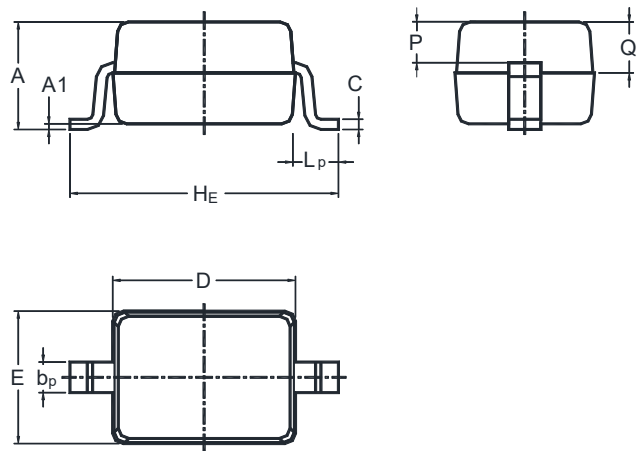


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PACKAGE OUTLINE

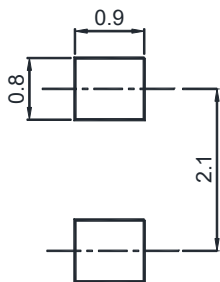
Plastic surface mounted package; 2 leads

SOD-323(Bend Lead)



UNIT	A	A ₁	b _D	C	D	E	H _E	L _P	Q	P
mm	1.1 0.8	0.1 0	0.4 0.25	0.18 0.09	1.8 1.6	1.35 1.15	2.8 2.3	0.5 0.1	0.5 0.3	0.4 0.3

Recommended Soldering Footprint



Packing information

Package	Tape Width (mm)	Pitch		Reel Size		Per Reel Packing Quantity
		mm	inch	mm	inch	
SOD-323BL	8	4 ± 0.1	0.157 ± 0.004	178	7	3,000

Marking information

" W2 " = Part No.
" III " = Cathode line
" • " = HAF (Halogen and Antimony Free)
Font type: Arial



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